

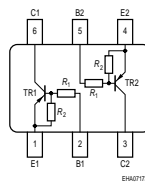
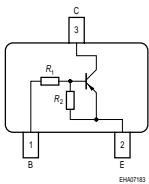
### PNP Silicon Digital Transistor

- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor ( $R_1 = 10\text{ k}\Omega$  ,  $R_2 = 47\text{ k}\Omega$  )
- BCR185S: Two internally isolated transistors with good matching in one multichip package
- BCR185S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package <sup>1)</sup>
- Qualified according AEC Q101



#### BCR185/F/W

#### BCR185S



| Type    | Marking | Pin Configuration |      |      |      |      |      | Package |
|---------|---------|-------------------|------|------|------|------|------|---------|
|         |         | 1=B               | 2=E  | 3=C  | -    | -    | -    |         |
| BCR185  | WNs     | 1=B               | 2=E  | 3=C  | -    | -    | -    | SOT23   |
| BCR185F | WNs     | 1=B               | 2=E  | 3=C  | -    | -    | -    | TSFP-3  |
| BCR185S | WNs     | 1=E1              | 2=B1 | 3=C2 | 4=E2 | 5=B2 | 6=C1 | SOT363  |
| BCR185W | WNs     | 1=B               | 2=E  | 3=C  | -    | -    | -    | SOT323  |

**Maximum Ratings**

| Parameter  | Symbol       | Value                    | Unit |
|--|--------------|--------------------------|------|
| Collector-emitter voltage  | $V_{CEO}$    | 50                       | V    |
| Collector-base voltage   | $V_{CBO}$    | 50                       |      |
| Input forward voltage  | $V_{i(fwd)}$ | 40                       |      |
| Input reverse voltage  | $V_{i(rev)}$ | 6                        |      |
| Collector current  | $I_C$        | 100                      | mA   |
| Total power dissipation-<br>BCR185 $T_S \leq 102^\circ\text{C}$<br>BCR185F, $T_S \leq 128^\circ\text{C}$<br>BCR185S, $T_S \leq 115^\circ\text{C}$<br>BCR185W, $T_S \leq 124^\circ\text{C}$ | $P_{tot}$    | 200<br>250<br>250<br>250 | mW   |
| Junction temperature   | $T_j$        | 150                      | °C   |
| Storage temperature  | $T_{stg}$    | -65 ... 150              |      |

**Thermal Resistance**

| Parameter                                | Symbol     | Value      | Unit |
|--|------------|------------|------|
| Junction - soldering point <sup>2)</sup> | $R_{thJS}$ |            | K/W  |
| BCR185                                   |            | $\leq 240$ |      |
| BCR185F                                  |            | $\leq 90$  |      |
| BCR185S                                  |            | $\leq 140$ |      |
| BCR185W                                  |            | $\leq 105$ |      |

<sup>1</sup>Pb-containing package may be available upon special request

<sup>2</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

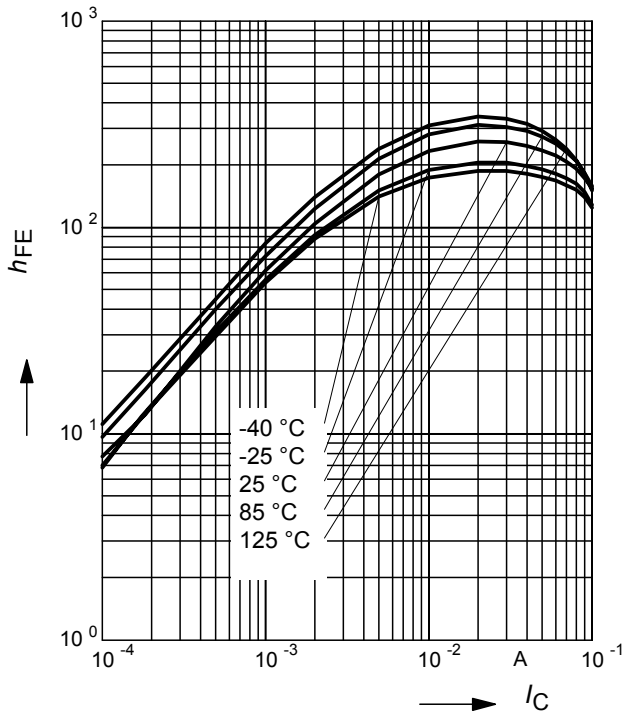
**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter   | Symbol        | Values |      |      | Unit             |
|---|---------------|--------|------|------|------------------|
|   |               | min.   | typ. | max. |                  |
| <b>DC Characteristics</b>   |               |        |      |      |                  |
| Collector-emitter breakdown voltage<br>$I_C = 100 \mu\text{A}, I_B = 0$                           | $V_{(BR)CEO}$ | 50     | -    | -    | V                |
| Collector-base breakdown voltage<br>$I_C = 10 \mu\text{A}, I_E = 0$                               | $V_{(BR)CBO}$ | 50     | -    | -    |                  |
| Collector-base cutoff current<br>$V_{CB} = 40 \text{ V}, I_E = 0$                                 | $I_{CBO}$     | -      | -    | 100  | nA               |
| Emitter-base cutoff current<br>$V_{EB} = 6 \text{ V}, I_C = 0$                                    | $I_{EBO}$     | -      | -    | 167  | $\mu\text{A}$    |
| DC current gain <sup>1)</sup><br>$I_C = 5 \text{ mA}, V_{CE} = 5 \text{ V}$                       | $h_{FE}$      | 70     | -    | -    | -                |
| Collector-emitter saturation voltage <sup>1)</sup><br>$I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ | $V_{CEsat}$   | -      | -    | 0.3  | V                |
| Input off voltage<br>$I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}$                                | $V_{i(off)}$  | 0.5    | -    | 1    |                  |
| Input on voltage<br>$I_C = 2 \text{ mA}, V_{CE} = 0.3 \text{ V}$                                  | $V_{i(on)}$   | 0.5    | -    | 1.4  |                  |
| Input resistor  | $R_1$         | 7      | 10   | 13   | $\text{k}\Omega$ |
| Resistor ratio  | $R_1/R_2$     | 0.19   | 0.21 | 0.24 | -                |
| <b>AC Characteristics</b>   |               |        |      |      |                  |
| Transition frequency<br>$I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$          | $f_T$         | -      | 200  | -    | MHz              |
| Collector-base capacitance<br>$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$                          | $C_{cb}$      | -      | 3    | -    | pF               |

<sup>1</sup>Pulse test:  $t < 300 \mu\text{s}$ ;  $D < 2\%$

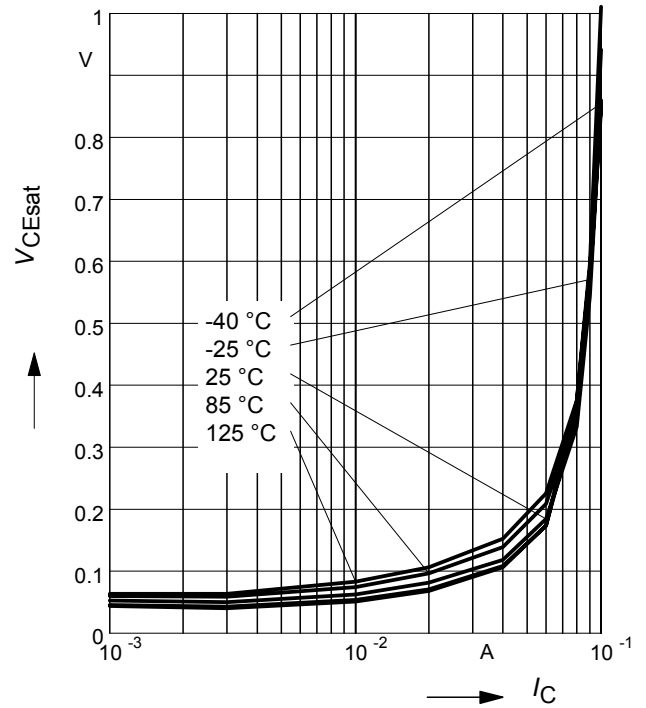
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 5\text{ V}$  (common emitter configuration)



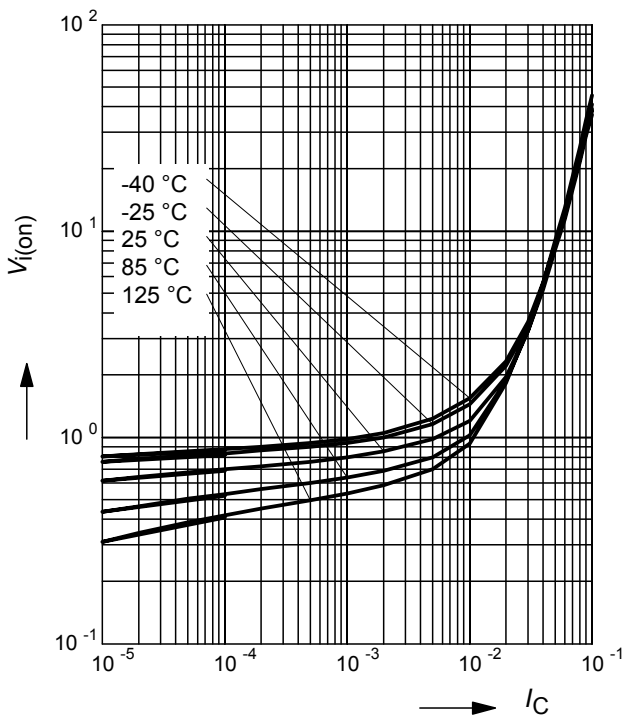
**Collector-emitter saturation voltage**

$V_{CEsat} = f(I_C), h_{FE} = 20$



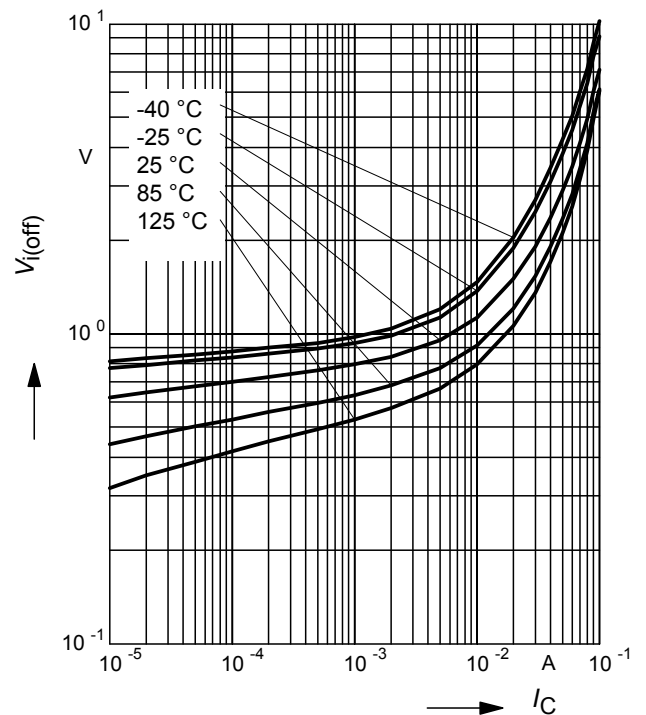
**Input on Voltage  $V_{i(on)} = f(I_C)$**

$V_{CE} = 0.3\text{ V}$  (common emitter configuration)



**Input off voltage  $V_{i(off)} = f(I_C)$**

$V_{CE} = 5\text{ V}$  (common emitter configuration)



Total power dissipation  $P_{tot} = f(T_S)$

BCR185



Total power dissipation  $P_{tot} = f(T_S)$

BCR185F



Total power dissipation  $P_{tot} = f(T_S)$

BCR185S



Total power dissipation  $P_{tot} = f(T_S)$

BCR185W



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

BCR185



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR185



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

BCR185F



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR185F



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

BCR185S



**Permissible Pulse Load**

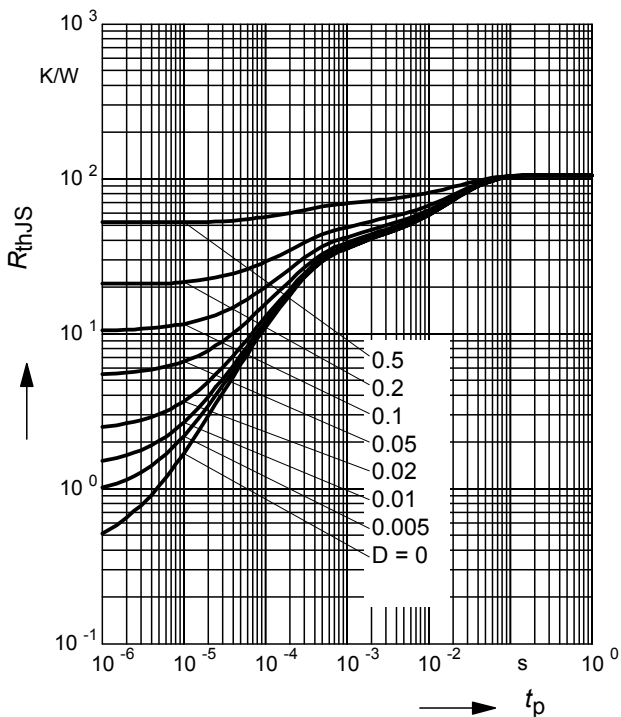
$P_{totmax}/P_{totDC} = f(t_p)$

BCR185S



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

BCR185W



**Permissible Pulse Load**

$P_{totmax}/P_{totDC} = f(t_p)$

BCR185W



Package Outline



1) Lead width can be 0.6 max. in dambar area

Foot Print



Marking Layout (Example)



Standard Packing

Reel  $\phi$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\phi$ 330 mm = 10.000 Pieces/Reel





Package Outline



Foot Print



Marking Layout (Example)

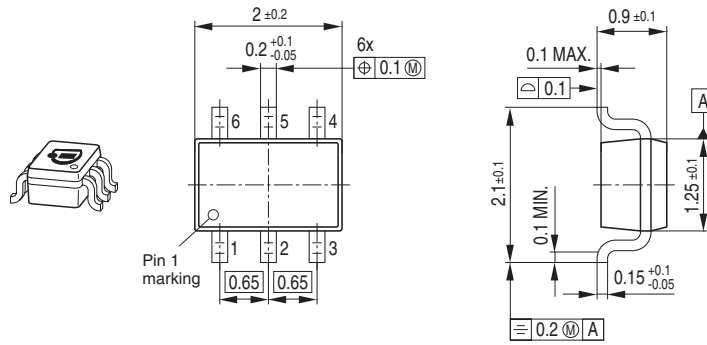


Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



Package Outline



Foot Print



Marking Layout (Example)

Small variations in positioning of Date code, Type code and Manufacture are possible.



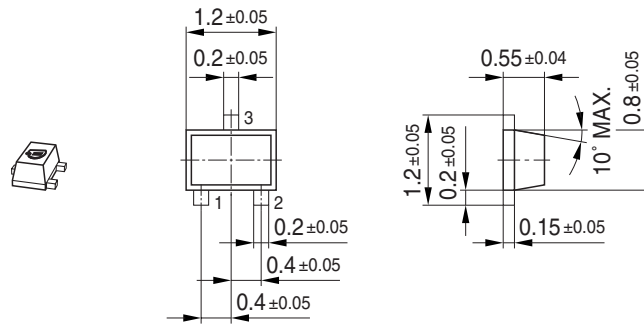
Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



Package Outline



Foot Print



Marking Layout (Example)



Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



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